

**Version With Markings to Show Changes Made**

4. (Twice Amended). A printed circuit board comprising:

- a) a plurality of spaced apart circuit layers;
- b) a drill or laser formed blind hole/via extending between a surface circuit layer and at least one other circuit layer, said blind hole/via having an electrical connect layer which electrically connects said surface circuit layer to said at least one other circuit layer; [and]
- c) a reflow pad for mounting a component to the surface circuit layer, said reflow pad [being generally coincident with] extending over a surface part of said electrical connect layer, and also extending over the blind hole/via; and
- d) an electro-conductive material filling the blind hole/via.